

## ■ General Description

The AME5287 is a Synchronous Rectified Step-Down Converter with internal power MOSFETs. It achieves 3A continuous output current over a wide switching frequency range with excellent load and line regulation.

Current mode operation provides fast transient response and eases of loop stabilization. Internal soft-start minimizes the inrush supply current at startup. The circuit protection includes cycle-by-cycle current limiting, output short circuit frequency protection and thermal shut-down. In shutdown mode, the regulator reduces the current less than 1 $\mu$ A of supply current.

This device is available in SOP-8/PP ,DFN-8 package with exposed pad for low thermal resistance.

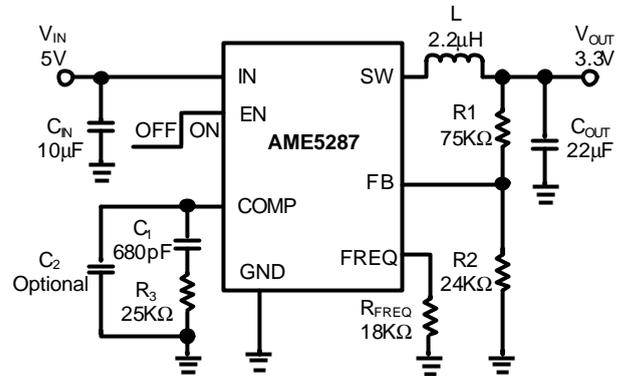
## ■ Features

- 3A Output Current
- Stable with Low ESR Output Ceramic Capacitors
- Pre-Regulator for Linear Regulators
- Up to 95% Efficiency
- Less than 1 $\mu$ A Shutdown Current
- Wide Switching Frequency Range from 300KHz~2MHz
- Thermal Protection
- Cycle-by-Cycle Over Current Protection
- Output Adjustable from 0.8V to  $V_{IN}$
- Short Circuit Protection
- Green Products Meet RoHS Standards

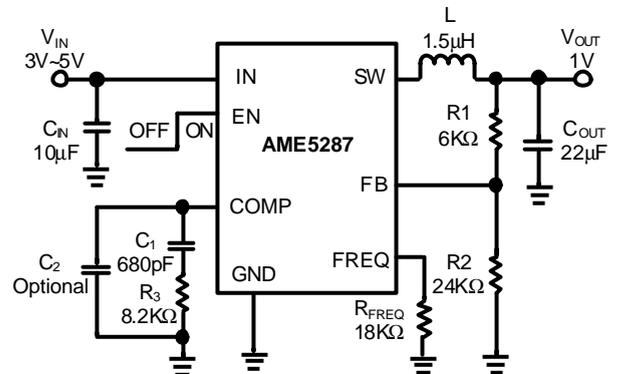
## ■ Applications

- TV
- Distributed Power Systems
- Pre-Regulator for Linear Regulators
- Digital Cameras

## ■ Typical Application



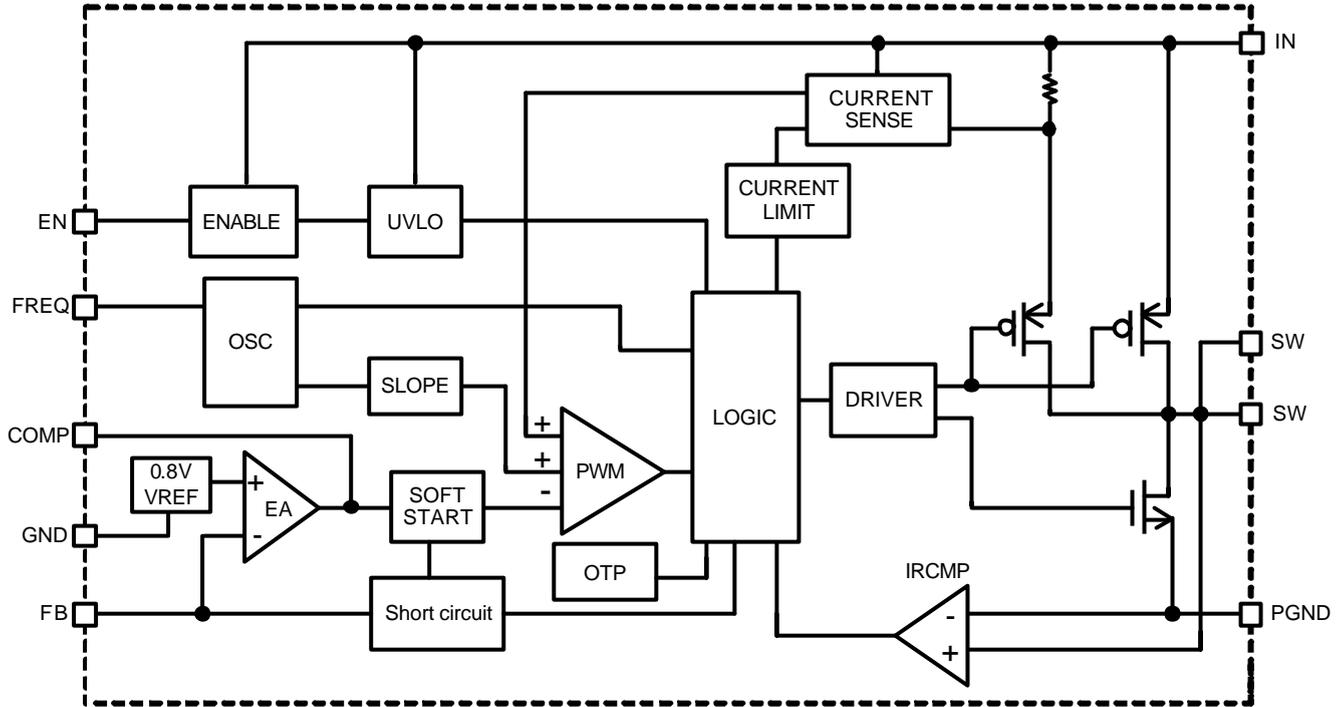
**Figure 1. 3.3V at 3A Step-Down Regulators.**



**Figure 2. 1V at 3A Step-Down Regulators.**

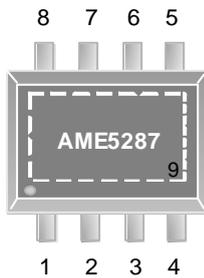
## AME5287

### ■ Functional Block Diagram



### ■ Pin Configuration

**SOP-8/PP**  
Top View

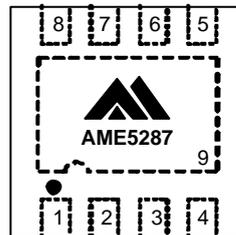


**AME5287-AZAADJ**

1. COMP
2. GND
3. EN
4. IN
5. SW
6. SW
7. FREQ
8. FB
9. GND (Exposed Pad)

\* Die Attach:  
Conductive Epoxy

**DFN-8C**  
(3mmx3mmx0.75mm)  
Top View



**AME5287-AVAADJ**

1. COMP
2. GND
3. EN
4. IN
5. SW
6. SW
7. FREQ
8. FB
9. GND (Exposed Pad)

\* Die Attach:  
Conductive Epoxy

Note. Connect exposed pad (heat sink on the back) to GND.

**■ Pin Description**

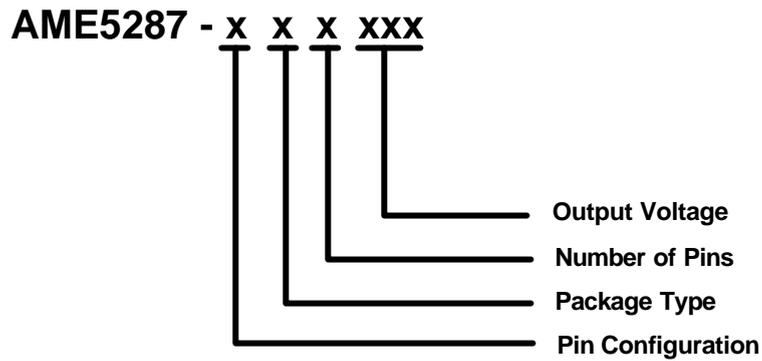
Pin No.	Pin Name	Pin Description
1	COMP	Compensation Node. COMP is used to compensate the regulation control loop. Connect a series RC network from COMP to GND to compensate the regulation control loop. In some cases, an additional capacitor from COMP to GND is required.
2	GND	Ground. Connect the exposed pad to GND.
3	EN	Enable. Pull EN below 0.4V to shut down the regulator.
4	IN	Power Input. IN supplies the power to the IC, as well as the step-down converter switches. Bypass IN to GND with a suitable large capacitor to eliminate noise on the input to the IC.
5, 6	SW	Power Switching Output. SW is the switching node that supplies power to the output. Connect the output LC filter from SW to the output load.
7	FREQ	Frequency Adjust Pin. Add a resistor from this pin to ground determines the switching frequency.
8	FB	Feedback Input. FB senses the output voltage to regulate that voltage. Drive FB with a resistive voltage divider from the output voltage. The feedback reference voltage is 0.8V.
9	GND	Ground. Connect the exposed pad to GND.



# 3A, 300KHz ~ 2MHz Synchronous Rectified Step-Down Converter

## AME5287

### ■ Ordering Information



Pin Configuration	Package Type	Number of Pins	Output Voltage
A 1. COMP (SOP-8/PP) 2. GND (DFN-8C) 3. EN 4. IN 5. SW 6. SW 7. FREQ 8. FB 9. GND	Z: SOP/PP V: DFN	A: 8	ADJ: Adjustable

**AME5287**
**■ Absolute Maximum Ratings**

Parameter	Symbol	Maximum	Unit
Supply Voltage	$V_{IN}$	6	V
Switch Voltage	$V_{SW}$	-1.5V to $V_{IN}+0.7V$	V
EN, FB, COMP, FREQ to GND		-0.3V to $V_{IN}+0.3V$	V
ESD Classification	HBM	2	kV
	MM	200	V

**■ Recommended Operating Conditions**

Parameter	Symbol	Rating	Unit
Ambient Temperature Range	$T_A$	-40 to +85	°C
Junction Temperature Range	$T_J$	-40 to +125	
Storage Temperature Range	$T_{STG}$	-65 to +150	

**■ Thermal Information**

Parameter	Package	Die Attach	Symbol	Maximum	Unit
Thermal Resistance* (Junction to Case)	SOP-8/PP	Conductive Epoxy	$\theta_{JC}$	15	°C / W
	DFN-8C			8.2	
Thermal Resistance (Junction to Ambient)	SOP-8/PP		$\theta_{JA}$	75	
	DFN-8C			70	
Internal Power Dissipation	SOP-8/PP		$P_D$	1.333	W
	DFN-8C			1.429	
Maximum Junction Temperature				150	°C
Lead Temperature (soldering 10 sec)**				260	°C

\* Measure  $\theta_{JC}$  on backside center of Exposed Pad.

\*\* MIL-STD-202G 210F

**AME5287**
**■ Electrical Specifications**
 $V_{IN}=5V$ ,  $T_A=25^{\circ}C$ , unless otherwise noted.

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Input Voltage	$V_{IN}$		3		5.5	V
Input UVLO	$V_{UVLO}$			2.3		V
Quiescent Current	$I_Q$	$V_{EN}=5V$ , $V_{FB}=0.7V$ (No Switching)		600		$\mu A$
Shutdown Current	$I_{SHDN}$	$V_{EN}=0V$			1	$\mu A$
Feedback Voltage	$V_{FB}$		0.784	0.8	0.816	V
Feedback Current	$I_{FB}$		-50		50	nA
Load Regulation	$REG_{LOAD}$	$0A < I_{OUT} < 2A$		0.25		%
Line Regulation	$REG_{LINE}$	$2.7V < V_{IN} < 5.5V$		0.25		%/V
EN Voltage High	$V_{EN}$		1.4			V
EN Voltage Low					0.4	V
EN Leakage Current	$I_{ENLK}$	$V_{EN}=3V$		0.1	1	$\mu A$
Switching Frequency	$F_{SW}$	$R_{FREQ}=NC$	240	300	360	KHz
		$R_{FREQ}=120K\Omega$	480	600	720	KHz
		$R_{FREQ}=47K\Omega$	0.8	1	1.2	MHz
		$R_{FREQ}=18K\Omega$	1.6	2		MHz
High-side Switch Current Limit				3.7		A
Error Amp Transconductance	$G_{EA}$			400		$\mu A/V$
Switch Leakage Current	$I_{SWLK}$	$V_{SW}=0V$ , $V_{EN}=0V$		0.1	20	$\mu A$
High-side Switch On Resistance	$R_{DSON,HI}$			130		m $\Omega$
Low-side Switch On Resistance	$R_{DSON,LO}$			90		m $\Omega$
Thermal Shutdown Protection	OTP	Rising		160		$^{\circ}C$
	OTH	Hysteresis		20		$^{\circ}C$

## ■ Detailed Description

### Normal Operation

The AME5287 uses a user adjustable frequency, current mode step-down architecture with internal MOSFET switch. During normal operation, the internal high-side (PMOS) switch is turned on each cycle when the oscillator sets the SR latch, and turned off when the comparator resets the SR latch. The peak inductor current at which comparator resets the SR latch is controlled by the output of error amplifier EA. While the high-side switch is off, the low-side switch turns on until either the inductor current starts to reverse or the beginning of the next switching cycle.

### Dropout Operation

The output voltage is dropped from the input supply for the voltage which across the high-side switch. As the input supply voltage decreases to a value approaching the output voltage, the duty cycle increases toward the maximum on-time. Further reduction of the supply voltage forces the high-side switch to remain on for more than one cycle until it reaches 100% duty cycle.

### Soft-Start

The AME5287 has a built-in digital soft-start to control the output voltage rise and limit the current surge at the start-up.

When the internal soft-start begins, and count 896 switching cycles, soft start is complete, the converter enters steady state operation.

### Hiccup Mode

During hiccup mode, the AME5287 disables the high-side MOSFET and begins a cool down period of 8320 switching cycles. At the conclusion of this cool down period, the regulator performs an internal 896 cycle soft start identical to the soft start at turn-on.

### Under Voltage Protection

Under Voltage Protection will activate once the feedback voltage falls below 0.4V, the operating frequency is switched to 1/10 of normal switching frequency and after four-times hiccup mode counted, the internal high-side power switch will be turned off, and latched. Unless Restart the power supply.

### Over Temperature Protection

In most applications the AME5287 does not dissipate much heat due to high efficiency. But, in applications where the AME5287 is running at high ambient temperature with low supply voltage and high duty cycles, such as in dropout, the heat dissipated may exceed the maximum junction temperature of the part. If the junction temperature reaches approximately 160°C, the internal high-side power switch will be turned off and the SW switch will become high impedance.

### Inductor Selection

For most applications, the value of the inductor will fall in the range of 2.2μH to 4.7μH. Its value is chosen based on the desired ripple current. Large value inductors lower ripple current and small value inductors result in higher ripple currents. Higher  $V_{IN}$  or  $V_{OUT}$  also increase the ripple current  $\Delta I_L$ :

$$\Delta I_L = \frac{1}{f \times L} V_{OUT} \left( 1 - \frac{V_{OUT}}{V_{IN}} \right)$$

A reasonable inductor current ripple is usually set as 1/3 to 1/5 of maximum out current. The DC current rating of the inductor should be at least equal to the maximum load current plus half the ripple current to prevent core saturation. For better efficiency, choose a low DCR inductor.

### Capacitor Selection

In continuous mode, the source current of the top MOSFET is a square wave of duty cycle  $V_{OUT}/V_{IN}$ . To prevent large voltage transients, a low ESR input capacitor sized for maximum RMS current must be used. The maximum RMS capacitor current is given by:

$$C_{IN} \text{ requires } I_{RMS} \cong I_{OMAX} \frac{\sqrt{V_{OUT}(V_{IN} - V_{OUT})}}{V_{IN}}$$

This formula has a maximum at  $V_{IN}=2V_{OUT}$ , where  $I_{RMS}=I_{OUT}/2$ . For simplification, use an input capacitor with a RMS current rating greater than half of the maximum load current.

The selection of  $C_{OUT}$  is driven by the required effective series resistance (ESR). Typically, once the ESR requirement for  $C_{OUT}$  has been met, the RMS current rating generally far exceeds the  $I_{RIPPLE(P-P)}$  requirement. The output ripple  $\Delta V_{OUT}$  is determined by:

$$\Delta V_{OUT} \cong \Delta I_L \left( ESR + \frac{1}{8fC_{OUT}} \right)$$

For a fixed output voltage, the output ripple is highest at maximum input voltage since  $\Delta I_L$  increases with input voltage.

When choosing the input and output ceramic capacitors, choose the X5R or X7R dielectric formulations. These dielectrics have the best temperature and voltage characteristics of all the ceramics for given value and size.

### Output Voltage Programming

The output voltage of the AME5287 is set by a resistive divider according to the following formula:

$$V_{OUT} = 0.8 \times \left[ 1 + \frac{R1}{R2} \right] \text{ Volt.}$$

### Loop Compensation

The AME5287 employs peak current mode control for easy use and fast transient response. Peak current mode control eliminates the double pole effect of the output LC filter. It greatly simplifies the compensation loop design.

With peak current mode control, the buck power stage can be simplified to be a one-pole and one-zero system in frequency domain. The pole can be calculated by:

$$f_{P1} = \frac{1}{2p \times C_{OUT} \times R_L}$$

The zero is a ESR zero due to output capacitor and its ESR. It can be calculated by:

$$f_{Z1} = \frac{1}{2p \times C_{OUT} \times ESR_{COUT}}$$

Where  $C_{OUT}$  is the output capacitor,  $R_L$  is load resistance;  $ESR_{C_{OUT}}$  is the equivalent series resistance of output capacitor.

The compensation design is to shape the converter close loop transfer function to get desired gain and phase. For most cases, a series capacitor and resistor network connected to the COMP pin sets the pole-zero and is adequate for a stable high-bandwidth control loop.

In the AME5287, FB pin and COMP pin are the inverting input and the output of internal transconductance error amplifier (EA). A series  $R_3$  and  $C_1$  compensation network connected to COMP pin provides one pole and one zero: for  $R_3 < A_{EA}/G_{EA}$ ,

$$f_{P2} = \frac{1}{2p \times C_1 \left( R_3 + \frac{A_{EA}}{G_{EA}} \right)} \approx \frac{G_{EA}}{2p \times C_1 \times A_{EA}}$$

$$f_{Z2} = \frac{1}{2p \times C_1 \times R_3}$$

where  $G_{EA}$  is the error amplifier transconductance

$A_{EA}$  is the error amplifier voltage gain

$R_3$  is the compensation resistor

$C_1$  is the compensation capacitor

The desired crossover frequency  $f_c$  of the system is defined to be the frequency where the control loop has unity gain. It is also called the bandwidth of the converter. In general, a higher bandwidth means faster response to load transient. However, the bandwidth should not be too high because of system stability concern. When designing the compensation loop, converter stability under all line and load condition must be considered. Usually, it is recommended to set the bandwidth to be less than 1/10 of switching frequency. Using selected crossover frequency,  $f_c$ , to calculate  $R_3$ :

$$R_3 = f_c \times \frac{V_{OUT}}{V_{FB}} \times \frac{2p \times C_{OUT}}{G_{EA} \times G_{CS}}$$

Where  $G_{CS}$  is the current sense circuit transconductance. The compensation capacitor  $C_1$  and resistor  $R_3$  together make zero. This zero is put somewhere close to the pole  $f_{P1}$  of selected frequency.  $C_1$  is selected by:

$$C_1 = \frac{C_{OUT} \times R_L}{R_3}$$

### Checking Transient Response

The regulator loop response can be checked by looking at the load transient response. Switching regulators take several cycles to respond to a step in load current. When a load step occurs,  $V_{OUT}$  immediately shifts by an amount equal to  $(\Delta I_{LOAD} \times ESR)$ , where ESR is the effective series resistance of  $C_{OUT}$ .  $\Delta I_{LOAD}$  also begins to charge or discharge  $C_{OUT}$ , which generates a feedback error signal.

The regulator loop then acts to return  $V_{OUT}$  to its steadystate value. During this recovery time  $V_{OUT}$  can be monitored for overshoot or ringing that would indicate a stability problem.

### Efficiency Considerations

Although all dissipative elements in the circuit produce losses, one major source usually account for most of the losses in AME5287 circuits:  $I^2R$  losses. The  $I^2R$  loss dominates the efficiency loss at medium to high load currents.

The  $I^2R$  losses are calculated from the resistances of the internal switches,  $R_{SW}$ , and external inductor  $R_L$ . In continuous mode, the average output current flowing through inductor L is "chopped" between the main switch and the synchronous switch. Thus the series resistance looking into the SW pin is a function of both top and bottom MOSFET  $R_{DS(ON)}$  and the duty cycle (D) as follows:

$$R_{SW} = (R_{DS(ON)TOP})(D) + (R_{DS(ON)BOTTOM})(1-D)$$

The  $R_{DS(ON)}$  for both the top and bottom MOSFETs can be obtained from Electrical Characteristics table. Thus, to obtain  $I^2R$  losses, simply add  $R_{SW}$  to  $R_L$  and multiply the result by the square of the average output current.



## 3A, 300KHz ~ 2MHz Synchronous Rectified Step-Down Converter

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### AME5287

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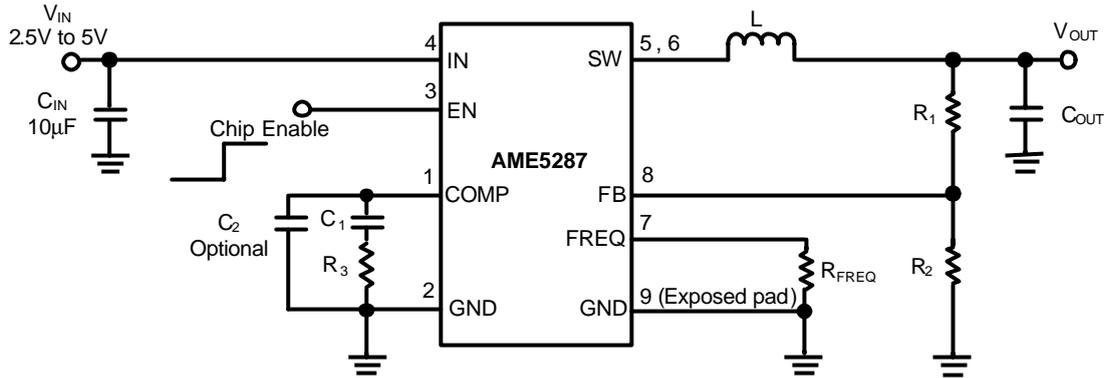
Other losses including  $C_{IN}$  and  $C_{OUT}$  ESR dissipative losses and inductor core losses generally account for less than 2% total additional loss.

#### Thermal Considerations

In most application the AME5287 does not dissipate much heat due to its high efficiency. But, in applications where the AME5287 is running at high ambient temperature with low supply voltage and high duty cycles, such as in dropout, the heat dissipated may exceed the maximum junction temperature of the part. If the junction temperature reaches approximately 160°C, both power switches will be turned off and the SW switch will become high impedance.

## AME5287

### ■ Typical Operating Circuit



$V_{OUT}(V)$	$C_{IN}(\mu F)$	$R1(K\Omega)$	$R2(K\Omega)$	$R3(K\Omega)$	$C1(pF)$	$L(\mu H)$	$C_{OUT}(\mu F)$
3.3	10	75	24	25	680	2.2	22
2.5	10	51	24	20	680	2.2	22
1.8	10	30	24	15	680	1.5	22
1.5	10	21	24	13	680	1.5	22
1.2	10	12	24	11	680	1.5	22
1	10	6	24	8.2	680	1.5	22

Table 1. Recommended Components Selectin for  $f_{sw} = 2MHz$

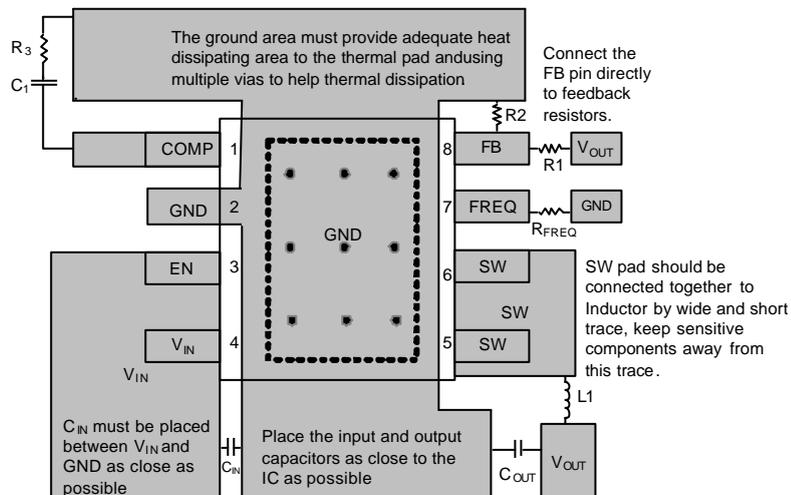
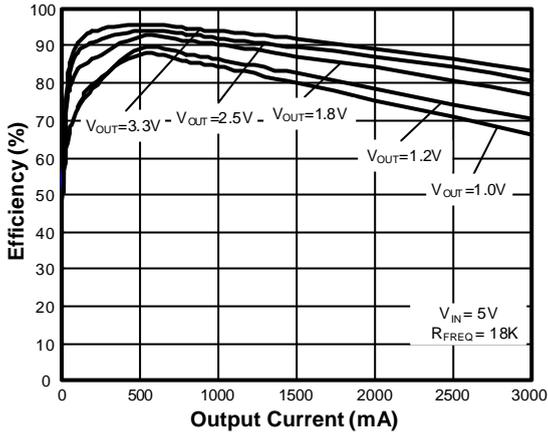
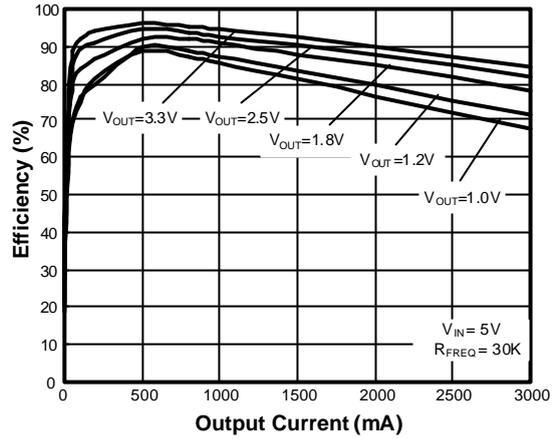
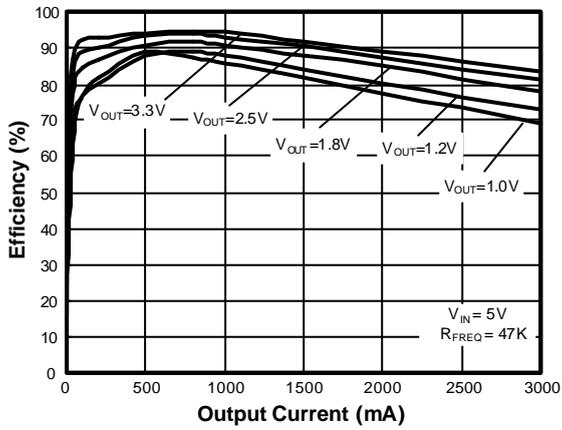
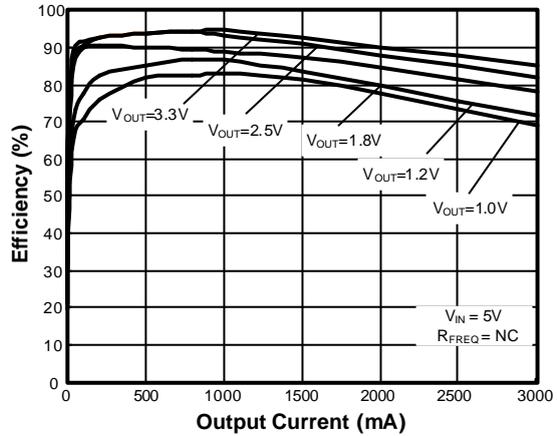
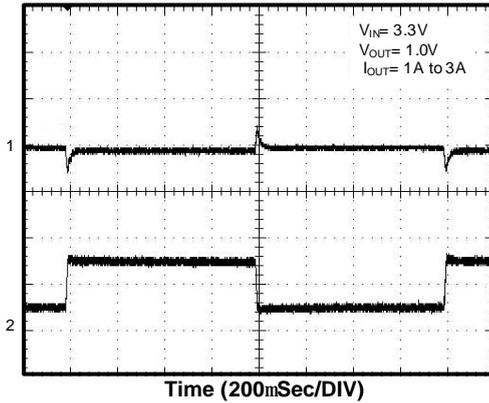
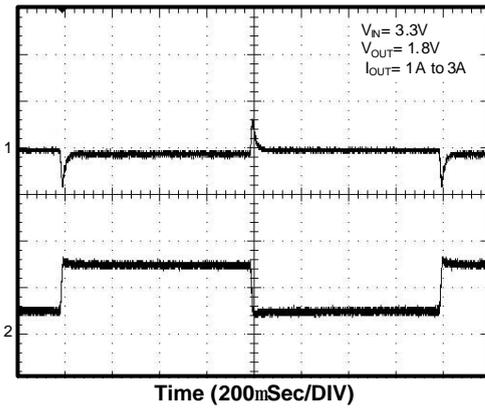


Figure 3. AME5287 Regulators Layout Diagram

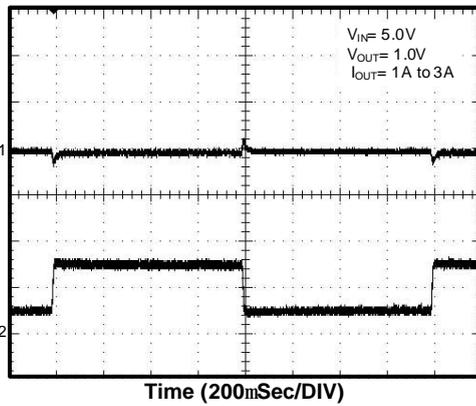
**■ Characterization Curve**
**Efficiency vs. Output Current**

**Efficiency vs. Output Current**

**Efficiency vs. Output Current**

**Efficiency vs. Output Current**


**■ Characterization Curve (Contd.)**
**Load Step**


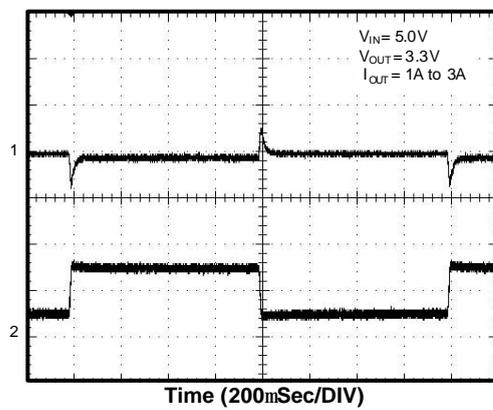
- 1)  $V_{OUT} = 200mV/div$
- 2)  $I_L = 2A/div$

**Load Step**


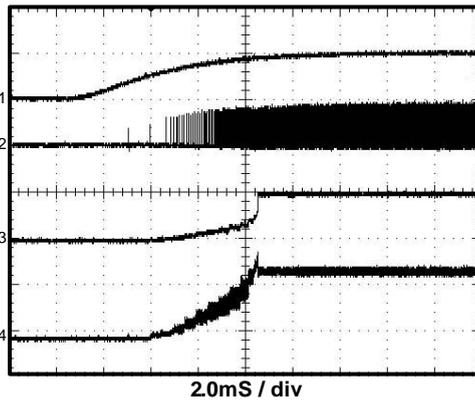
- 1)  $V_{OUT} = 200mV/div$
- 2)  $I_L = 2A/div$

**Load Step**


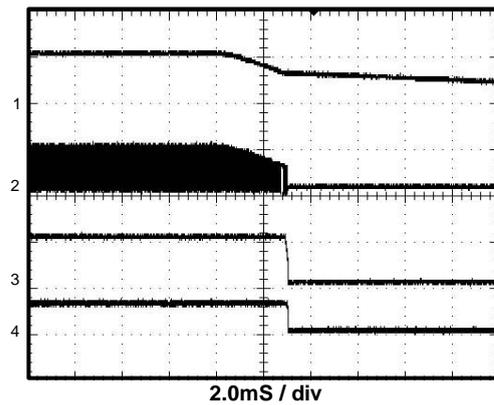
- 1)  $V_{OUT} = 200mV/div$
- 2)  $I_L = 2A/div$

**Load Step**


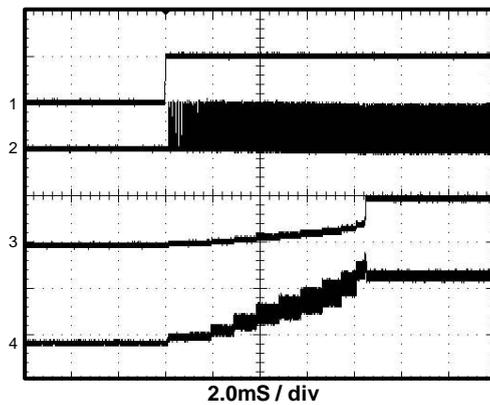
- 1)  $V_{OUT} = 200mV/div$
- 2)  $I_L = 2A/div$

**■ Characterization Curve (Contd.)**
**Power ON from  $V_{IN}$** 


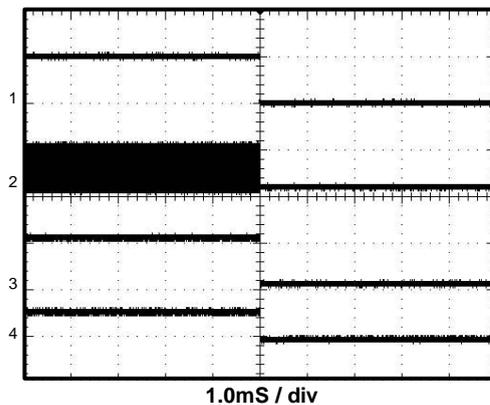
- 1)  $V_{IN} = 5V/div$
- 2)  $V_{sw} = 5V/div$
- 3)  $V_{OUT} = 1V/div$
- 4)  $I_L = 2A/div$

**Power off from  $V_{IN}$** 


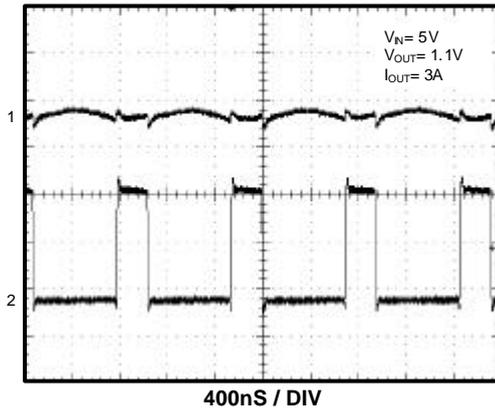
- 1)  $V_{IN} = 5V/div$
- 2)  $V_{sw} = 5V/div$
- 3)  $V_{OUT} = 1V/div$
- 4)  $I_L = 5A/div$

**Start-Up from EN**


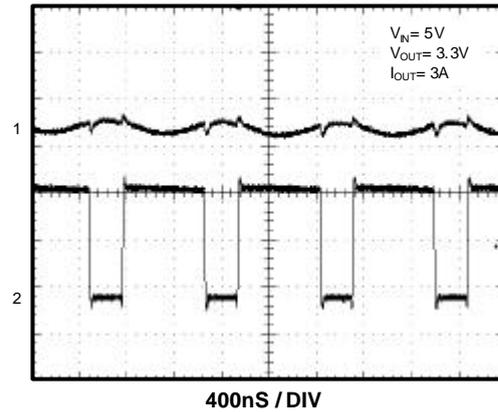
- 1)  $EN = 5V/div$
- 2)  $V_{sw} = 5V/div$
- 3)  $V_{OUT} = 1V/div$
- 4)  $I_L = 2A/div$

**Power Off from EN**


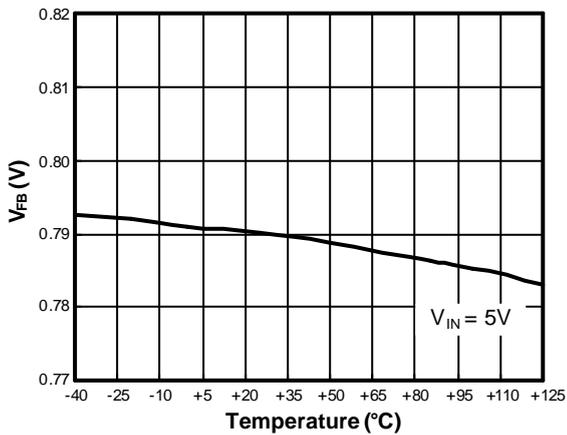
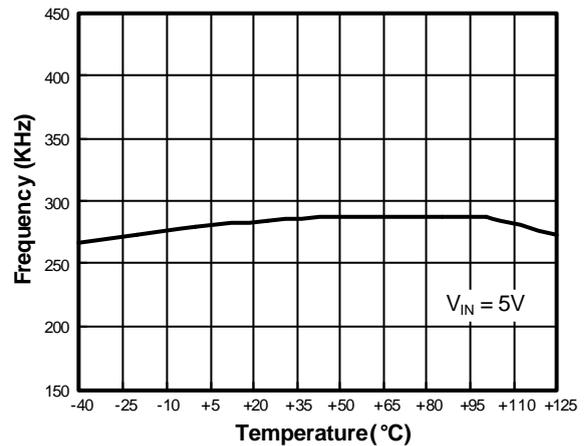
- 1)  $EN = 5V/div$
- 2)  $V_{sw} = 5V/div$
- 3)  $V_{OUT} = 1V/div$
- 4)  $I_L = 5A/div$

**■ Characterization Curve (Contd.)**
**Steady State Test**


- 1)  $V_{OUT} = 10mV/div$
- 2)  $V_{SW} = 2V/div$

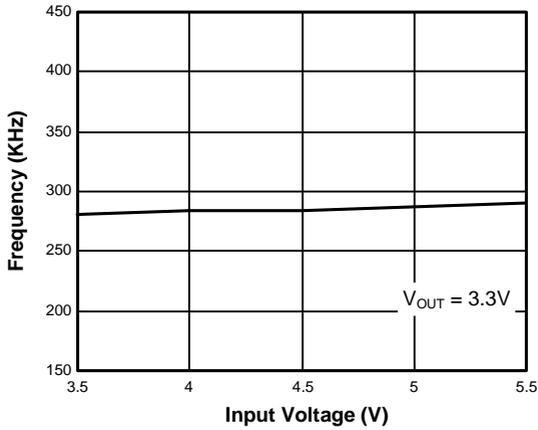
**Steady State Test**


- 1)  $V_{OUT} = 10mV/div$
- 2)  $V_{SW} = 2V/div$

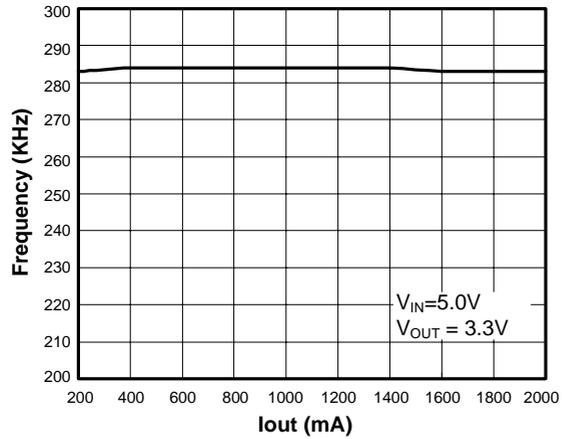
 **$V_{FB}$  vs. Temperature**

**Frequency vs. Temperature**


### ■ Characterization Curve (Contd.)

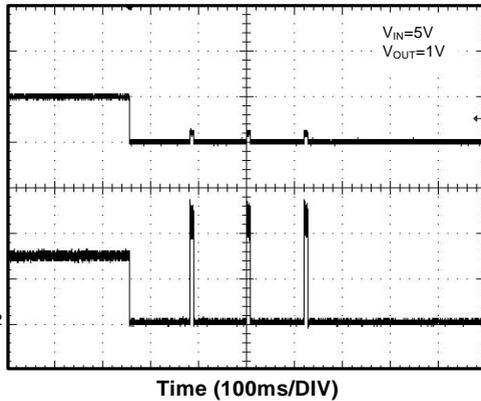
Frequency vs. Supply Voltage



Frequency vs. Output Current

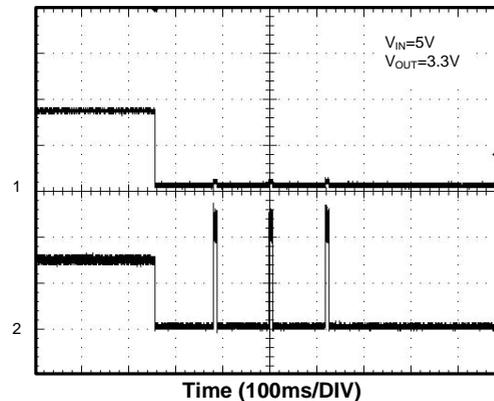


Short Circuit Test

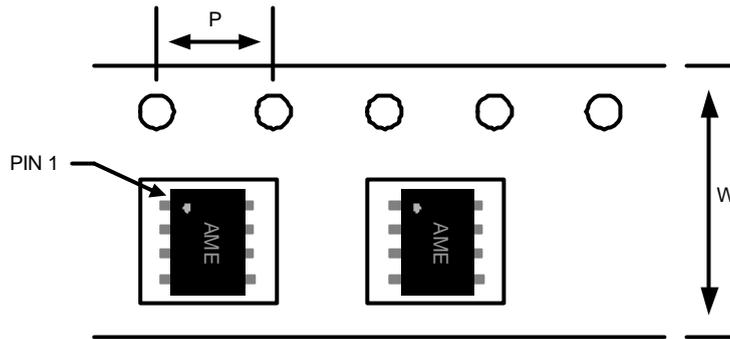


- 1)  $V_{OUT} = 1V/div$
- 2)  $I_{OUT} = 2A/div$

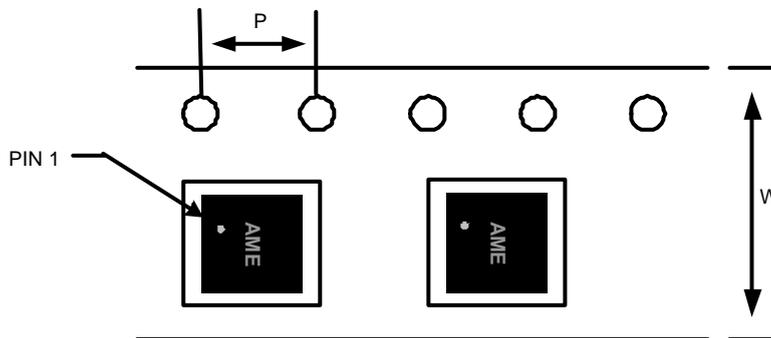
Short Circuit Test



- 1)  $V_{OUT} = 2V/div$
- 2)  $I_{OUT} = 2A/div$

**AME5287**
**■ Tape and Reel Dimension**
**SOP-8/PP**

**Carrier Tape, Number of Components Per Reel and Reel Size**

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
SOP-8/PP	12.0±0.1 mm	4.0±0.1 mm	2500pcs	330±1 mm

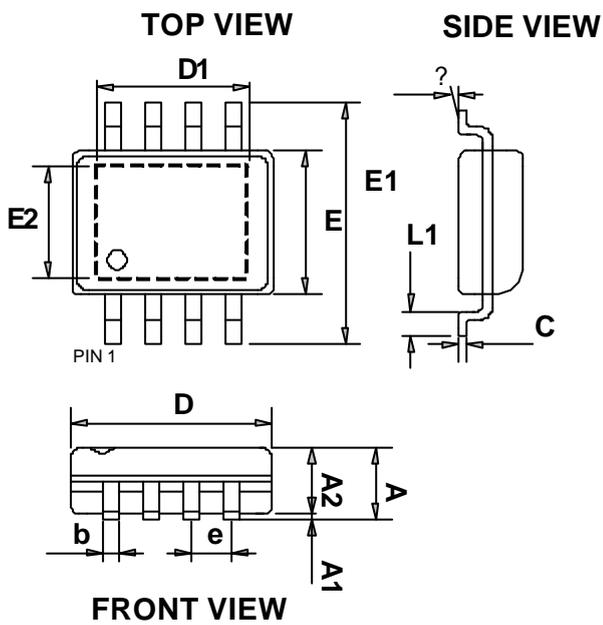
**DFN-8C  
(3mmx3mmx0.75mm)**

**Carrier Tape, Number of Components Per Reel and Reel Size**

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
DFN-8C (3x3x0.75mm)	12.0±0.1 mm	4.0±0.1 mm	3000pcs	330±1 mm

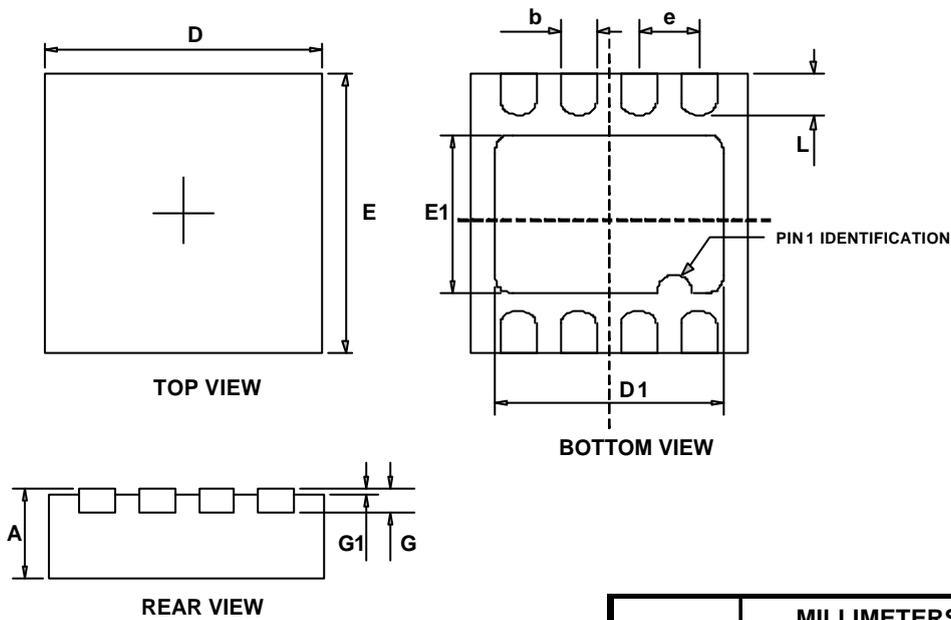
### AME5287

#### ■ Package Dimension

SOP-8/PP



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.350	1.750	0.053	0.069
A1	0.000	0.150	0.000	0.006
A2	1.350	1.600	0.053	0.063
C	0.100	0.250	0.004	0.010
E	3.750	4.150	0.148	0.163
E1	5.700	6.300	0.224	0.248
L1	0.300	1.270	0.012	0.050
b	0.310	0.510	0.012	0.020
D	4.720	5.120	0.186	0.202
e	1.270 BSC		0.050 BSC	
q	0°	8°	0°	8°
E2	2.150	2.513	0.085	0.099
D1	2.150	3.402	0.085	0.134

**AME5287**
**■ Package Dimension (Contd.)**
**DFN-8C  
(3mmx3mmx0.75mm)**


SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
<b>A</b>	0.700	0.800	0.028	0.031
<b>D</b>	2.900	3.100	0.114	0.122
<b>E</b>	2.900	3.100	0.114	0.122
<b>e</b>	0.600	0.700	0.024	0.028
<b>D1</b>	2.200	2.400	0.087	0.094
<b>E1</b>	1.400	1.600	0.055	0.063
<b>b</b>	0.180	0.320	0.007	0.013
<b>L</b>	0.375	0.575	0.015	0.023
<b>G</b>	0.153	0.253	0.006	0.010
<b>G1</b>	0.000	0.050	0.000	0.002



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